



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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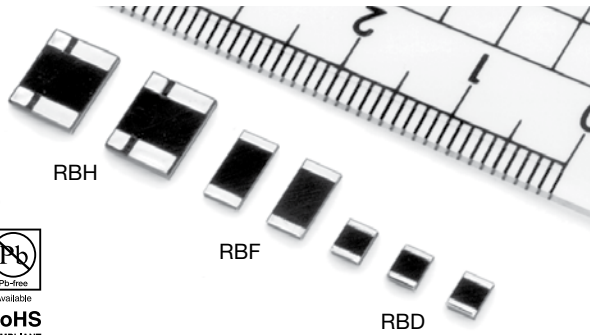
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Ultra Precision SMT Current Sense Resistor (Flip-Chip)



TCR, RESISTANCE RANGE, TOLERANCE, RATED POWER				
Type	TCR (ppm/°C) -25°C to 125°C*	Resistance Range (Ω)	Resistance Tolerance (%)*	Rated Power (W) at 70°C
RBD	0±25 (J)	0.01 to 0.1	±1 (F) ±2 (G) ±5 (J)	0.5
	0±10 (C) 0±25 (J)	0.1 to 1	±0.5 (D) ±1 (F) ±2 (G) ±5 (J)	
RBF	0±25 (J)	0.01 to 0.1	±1 (F) ±2 (G) ±5 (J)	1
	0±10 (C) 0±25 (J)	0.1 to 1	±0.5 (D) ±1 (F) ±2 (G) ±5 (J)	
RBH	0±10 (C) 0±25 (J)	0.01 to 0.1	±0.5 (D) ±1 (F) ±2 (G) ±5 (J)	1.5

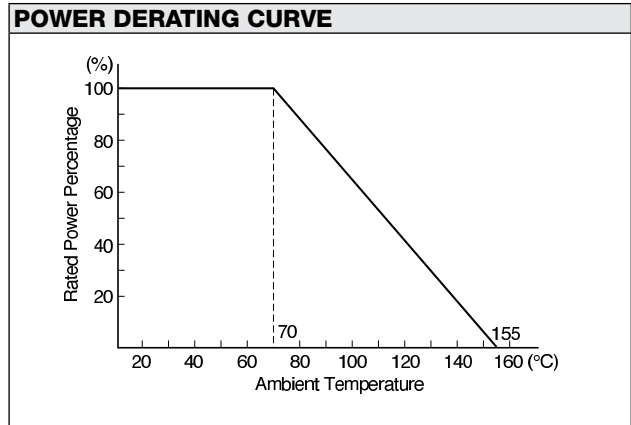
*Symbols parenthesized are for type number composition.

COMPOSITION OF TYPE NUMBER

Example:
RBF J R1000 F L

- Tape & Reel Package Required
- Tolerance
- Resistance Value
- TCR
- Type

Resistance value in ohm is expressed by a series of four significant digits and an R designates the decimal point.



CONFIGURATION (DIMENSIONS IN mm)

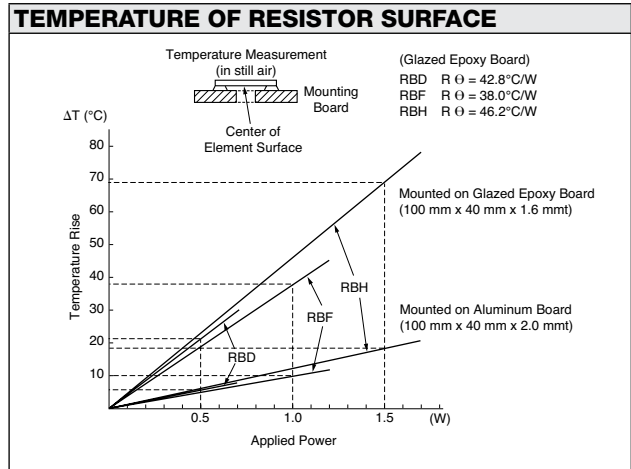
Type	RBD	RBF
L	3.2±0.1	6.3±0.1
W	2.5±0.1	3.2±0.1
L ₁	0.5±0.2	0.7±0.2
L ₂	2.1±0.2	4.7±0.2
W ₁	2.4±0.2	3.0±0.2
T	1.05 max.	

Dimensions in mm

Type	RBH
L	7.5±0.1
W	6.0±0.1
L ₁	1.4±0.2
L ₂	4.4±0.2
W ₁	1.4±0.2
W ₂	0.7±0.2
W ₃	3.6±0.2
T	1.5 max.

Dimensions in mm

I: Current Sensing Terminal
V: Voltage Terminal



Please use board made of metal for continuous use with 2W at 70°C. Please keep the temperature of board less than 90°C when using the glazed epoxy board.

CONSTRUCTION

- Ceramic Substrate (High-Purity Alumina)
- Heat-Resistant Bonding Layer
- Bulk[®] Metal Foil
- Metal Plating
- Solder
- Solder-Resist

PERFORMANCE			
Parameters	Test Condition	ALPHA Specification	ALPHA Typical Test Data
Maximum Rated Operating Temperature		70°C	
Working Temperature Range		-65°C to +155°C	
Thermal Shock Overload	-65°C/30 min. ↔ +155°C/30 min., 5 cycles Rated Voltage x 2.5, 5 sec.	±0.1% ±0.1%	±0.03% ±0.03%
Low Temperature Storage and Operation	-65°C, No Load, 24 hrs. → Rated Voltage, 45 min.	±0.1% ±0.1%	±0.05% ±0.05%
Substrate Bending Test	Substrate Bent 3 mm, 60 sec.		
Dielectric Withstanding Voltage	Atmo. Pres.: AC 200V, 1 min.	±0.05% over 10,000 MΩ	±0.01% over 10,000 MΩ
Insulation Resistance	DC 100V, 1 min.		
Resistance to Soldering Heat	260°C, 10 sec.	±0.1% ±0.1%	±0.03% ±0.03%
Moisture Resistance	+65°C to -10°C, 90% RH to 98% RH, Rated Voltage, 10 cycles (240 hrs.)		
Shock	100G, 6 ms, Sawtooth Wave, X, Y, Z, each 10 shocks	±0.05% ±0.05%	±0.01% ±0.01%
Vibration, High Frequency	20G, 10 Hz to 2,000 Hz to 10 Hz, 20 min., X, Y, Z, each 2.5 hrs.		
Life	70°C, Rated Power, 1.5 hr. – ON, 0.5 hr. – OFF, 2,000 hrs	±0.1% ±0.1%	±0.05% ±0.05%
Storage Life	15°C to 35°C, 15% RH to 75% RH, No Load, 10,000 hrs.	±0.05% ±0.05%	±0.01% ±0.01%
High Temperature Exposure	155°C, No Load, 2,000 hrs.	±0.1% ±0.1%	±0.05% ±0.05%

TAPE AND REEL PACKAGE (BASED ON EIA-481-1) (DIMENSIONS IN mm)

Tape Dimensions										Reel Dimensions Reel Capacity RBH: 1,000 pieces/reel RBD, RBF: 4,000 pieces/reel								
<p>RBD, RBF: 0.25±0.05 RBH: 0.30±0.05</p> <p>RBD, RBF: 1.2±0.1 RBH: 1.80±0.1</p>																		
Type	A0	B0	W	F	E	P1	P2	P0	D0	Type	A	N	B	C	D	W1	W2	r
RBD	2.85 ±0.1	3.7 ±0.1	8.0 ±0.2	3.5 ±0.05	1.75 ±0.1	4.0 ±0.1	2.0 ±0.05	4.0 ±0.1	Dia.1.5 +0.1-0	RBD	Dia.178 ±2	Dia.60 min.	Dia.13 ±0.5	Dia.21 ±0.8	2.0 ±0.5	8.4 +2.0-0	14.4 max.	1.0 ±0.5
RBF	3.4 ±0.1	6.7 ±0.1	12.0 ±0.2	5.5 ±0.05	1.75 ±0.1	4.0 ±0.1	2.0 ±0.05	4.0 ±0.1	Dia.1.5 +0.1-0	RBF	Dia.178 ±2	Dia.60 min.	Dia.13 ±0.5	Dia.21 ±0.8	2.0 ±0.5	12.4 +2.0-0	18.4 max.	1.0 ±0.5
RBH	6.3 ±0.1	7.8 ±0.1	16.0 ±0.2	7.5 ±0.1	1.75 ±0.1	8.0 ±0.1	2.0 ±0.1	4.0 ±0.1	Dia.1.5 +0.1-0	RBH	Dia.178 ±2	Dia.60 min.	Dia.13 ±0.5	Dia.21 ±0.8	2.0 ±0.5	17.0 ±0.3	19.4 ±0.1	1.0 ±0.5

PRECAUTION IN USING SMD CURRENT SENSE RESISTORS

1. Storage

Storage condition or environment may adversely affect solderability of the exterior terminals. Do not store in high temperature and humidity. The recommended storage environment is lower than 40°C, has less than 70% RH humidity and is free from harmful gases such as sulphur and chlorine.

2. Caution in Soldering

- ① Solder Reflow in Furnace Recommended
 - Peak Temperature: 250+0/-5°C
 - Holding time: 10 sec. max.
 - To cool gradually at room temperature.
- ② Dipping in Solder (Wave or Still) Recommended
 - Temp. of Solder: 260°C max.
 - Length of Dipping: 10 sec.

③ Other
Soldering iron is never recommended. Corrosion-free flux such as rosin is recommended.

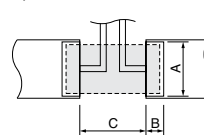
3. Cleaning

Use volatile cleaner such as methylalcohol or propylalcohol.

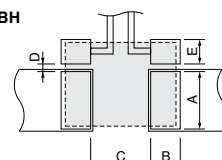
4. Circuit Board Design

- ① Solder Land Dimensions
The dimensions of solder land must be determined in conformity with the size of resistors and with the soldering method. They are also subject to the mounting machine and the material of the substrate. See example at right.

RBD, RBF



RBH



Type	Dimensions in mm				
	A	B	C	D	E
RBD	2.6 to 2.8	0.8	2.0	/	/
RBF	3.4 to 3.6	1.2	4.5		
RBH	3.8 to 4.0	2.0	4.0		

② Circuit Design

It is recommended that the circuit be drawn so that current may approach, cross and go away from the mounted resistor in one direction as illustrated below. Thicker copper foil should be used if possible.

